

DPDT SWITCH GaAs MMIC

■ GENERAL DESCRIPTION

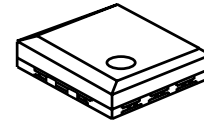
NJG1602HE3 is a GaAs high power DPDT switch MMIC for antenna switch of tri- and dual-mode cellular phone application such as CDMA, GPS and PCS.

This switch features low loss, high isolation at high power.

This device includes logic decoder function, and can be operated by 1 bit control signal for path switching.

The ultra small & ultra thin USB12 package is adopted.

■ PACKAGE OUTLINE

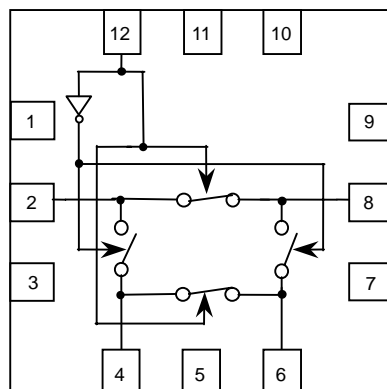


■ FEATURES

- Low voltage operation +2.5V min.
- Pin at 0.2dB compression point 36dBm typ. @f=0.9GHz, $V_{CTL}=2.7V$
- Low insertion loss 0.3dB typ. @f=0.9GHz, $P_{IN}=25dBm$, $V_{CTL}=2.7V$
0.55dB typ. @f=1.9GHz, $P_{IN}=25dBm$, $V_{CTL}=2.7V$
- High isolation 21dB typ. @f=0.9GHz, $P_{IN}=25dBm$, $V_{CTL}=2.7V$
15dB typ. @f=1.9GHz, $P_{IN}=25dBm$, $V_{CTL}=2.7V$
- Low current consumption 17uA typ. @f=0.9GHz, $P_{IN}=25dBm$, $V_{CTL}=2.7V$
- Ultra small & ultra thin package USB12-E3 (Package size: 2.35x2.35x0.75mm)

■ PIN CONFIGURATION

USB12Type
(Top View)



Pin connection

1. VDD
2. P1
3. GND
4. P2
5. GND
6. P3
7. GND
8. P4
9. GND
10. GND
11. GND
12. CTL

■ TRUTH TABLE

“H”=CTL(H), “L”=CTL(L)

CTL	H	L
P1-P4, P2-P3	ON	OFF
P1-P2, P3-P4	OFF	ON

NOTE: Please note that any information on this catalog will be subject to change.

NJG1602HE3

■ ABSOLUTE MAXIMUM RATINGS

($T_a=+25^{\circ}\text{C}$, $Z_s=Z_l=50\Omega$)

PARAMETER	SYMBOL	CONDITIONS	CONDITIONS	UNITS
RF Input Power	P_{IN}	$V_{DD}=2.7\text{V}$, $CTL=0\text{V}/2.7\text{V}$	37	dBm
Supply Voltage	V_{DD}	VDD terminal	7.5	V
Control Voltage	V_{CTL}	CTL terminal	7.5	V
Power Dissipation	P_D		250	mW
Operating Temp.	T_{opr}		-40~+85	$^{\circ}\text{C}$
Storage Temp.	T_{stg}		-55~+150	$^{\circ}\text{C}$

■ ELECTRICAL CHARACTERISTICS

(General conditions: $T_a=+25^{\circ}\text{C}$, $Z_s=Z_l=50\Omega$, $V_{DD}=2.7\text{V}$, $CTL(L)=0\text{V}$, $CTL(H)=2.7\text{V}$)

PARAMETERS	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Operating Current	I_{DD}	$P_{IN}=25\text{dBm}$	-	70	100	μA
Supply Voltage	V_{DD}		-	2.7	5.5	V
Control Voltage (LOW)	CTL(L)		0	-	0.8	V
Control Voltage (HIGH)	CTL(H)		2.5	2.7	V_{DD}	V
Control Current	I_{CTL}	$f=0.9\text{GHz}$, $P_{IN}=25\text{dBm}$	-	17	30	μA
Insertion Loss 1	LOSS1	$f=0.9\text{GHz}$, $P_{IN}=25\text{dBm}$	-	0.3	0.4	dB
Insertion Loss 2	LOSS2	$f=1.9\text{GHz}$, $P_{IN}=25\text{dBm}$	-	0.55	0.7	dB
Isolation 1	ISL1	$f=0.9\text{GHz}$, $P_{IN}=25\text{dBm}$	20	21	-	dB
Isolation 2	ISL2	$f=1.9\text{GHz}$, $P_{IN}=25\text{dBm}$	14	15	-	dB
Pin at 0.2dB Compression Point	$P_{-0.2\text{dB}}$	$f=1.9\text{GHz}$	33	36	-	dBm
2nd Harmonics 1	$2f_0(1)$	$f=0.9\text{GHz}$, $P_{IN}=25\text{dBm}$	-	-80	-65	dBc
2nd Harmonics 2	$2f_0(2)$	$f=1.9\text{GHz}$, $P_{IN}=25\text{dBm}$	-	-75	-70	dBc
3rd Harmonics 1	$3f_0(1)$	$f=0.9\text{GHz}$, $P_{IN}=25\text{dBm}$	-	-75	-60	dBc
3rd Harmonics 2	$3f_0(2)$	$f=1.9\text{GHz}$, $P_{IN}=25\text{dBm}$	-	-70	-60	dBc
Input 3 rd order intercept Point 1	IIP3(1)	$f=900+901\text{MHz}$, $P_{in}=25\text{dBm}$ *1	56	62	-	dBm
Input 3 rd order intercept Point 2	IIP3(2)	$f=1900+1901\text{MHz}$, $P_{in}=25\text{dBm}$ *1	54	60	-	dBm
VSWR	$VSWR_i$	on-state ports, $f=0.9\text{GHz}$	-	1.1	1.4	
Switching time	T_{SW}	$f=0.1\sim 2.5\text{GHz}$	-	1.2	-	μs

*1: The input IP3 is defined as following equation.

$$IIP3=(3 \times P_{out} - IM3) / 2 + LOSS$$

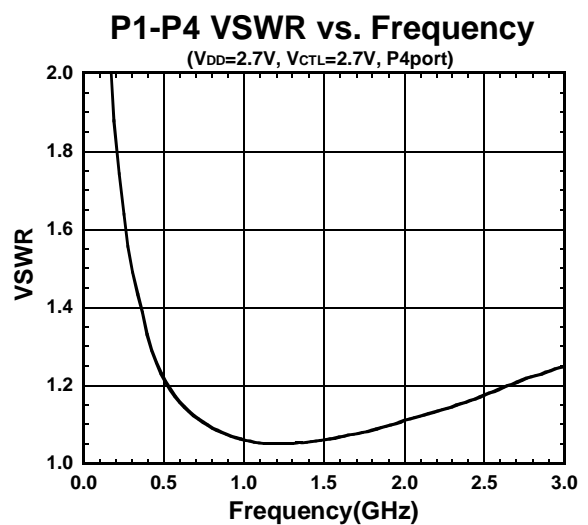
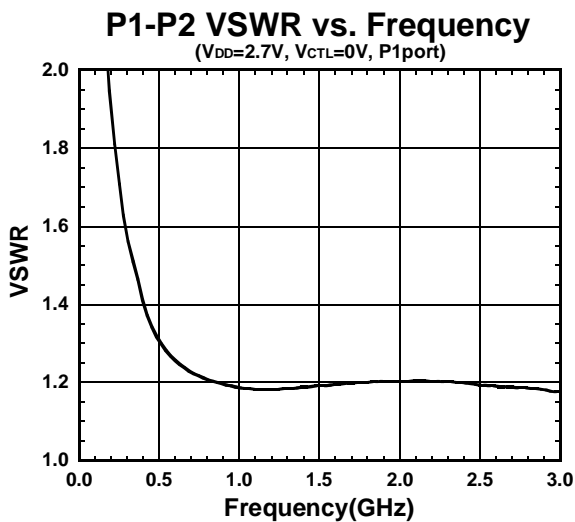
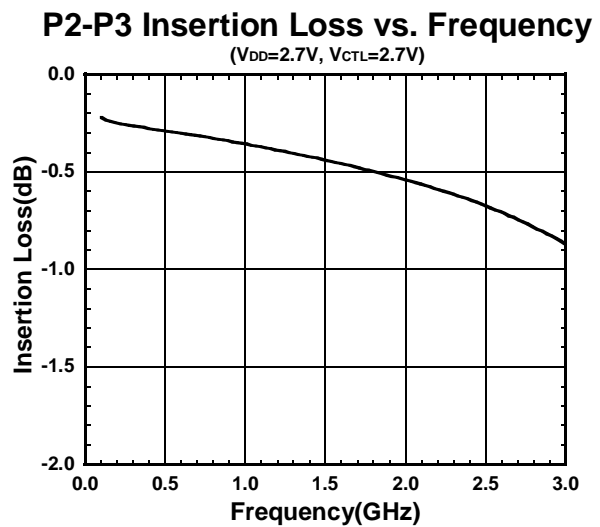
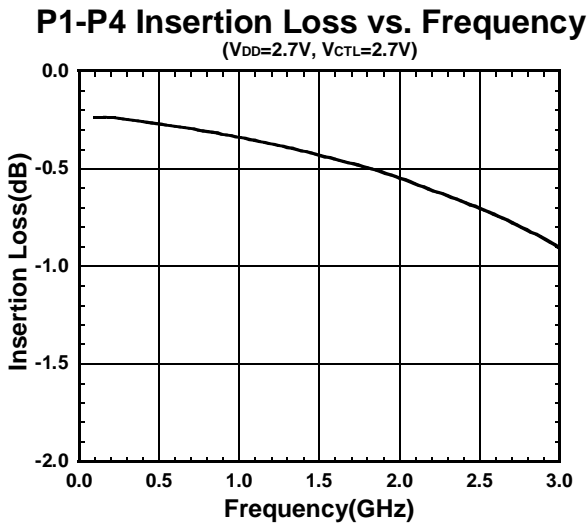
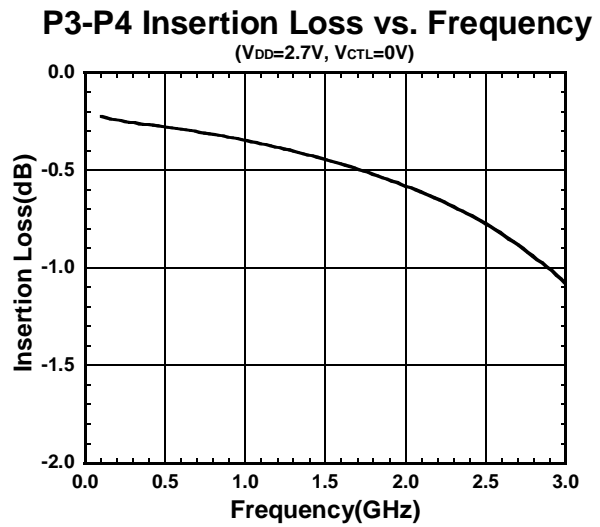
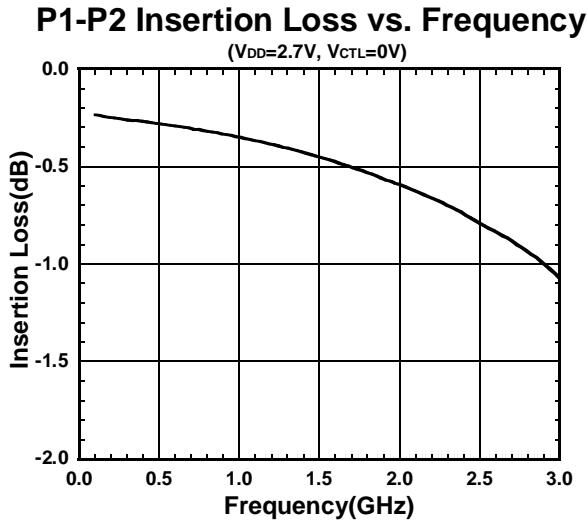
■ TERMINAL INFORMATION

No.	SYMBOL	DESCRIPTION
1	VDD	Positive voltage supply terminal. The positive voltage (+2.5~+5.5V) have to be supplied. Please connect a bypass capacitor with GND terminal for excellent RF performance.
2	P1	RF port. This port is connected with P4 port by controlling 12pin-CTL(H) (+2.5~+VDD). This port is connected with P2 port by controlling 12pin- CTL(L) (0~+0.8V) . A DC cut capacitor 56pF is required at this terminal to block DC voltage of inner circuit.
3	GND	Ground terminal. Please connect this terminal with ground plane as close as possible for excellent RF performance.
4	P2	RF port. This port is connected with P3 port by controlling 12pin- CTL(L) (0.2~+0.8V). This port is connected with P3 port by controlling 12pin- CTL(H)(+2.5~+VDD). A DC cut capacitor 56pF is required at this terminal to block DC voltage of inner circuit.
5	GND	Ground terminal. Please connect this terminal with ground plane as close as possible for excellent RF performance.
6	P3	RF port. This port is connected with P2 port by controlling 12pin- CTL(H) (+2.5~+VDD). This port is connected with P4 port by controlling 12pin-V _{CTL(L)} (0~+0.8V). A DC cut capacitor 56pF is required at this terminal to block DC voltage of inner circuit.
7	GND	Ground terminal. Please connect this terminal with ground plane as close as possible for excellent RF performance.
8	P4	RF port. This port is connected with P1 port by controlling 12pin- CTL(H) (+2.5~+VDD). This port is connected with P3 port by controlling 12pin- CTL(L) (0~+0.8V). A DC cut capacitor 56pF is required at this terminal to block DC voltage of inner circuit.
9	GND	Ground terminal. Please connect this terminal with ground plane as close as possible for excellent RF performance.
10	GND	Ground terminal. Please connect this terminal with ground plane as close as possible for excellent RF performance.
11	GND	Ground terminal. Please connect this terminal with ground plane as close as possible for excellent RF performance.
12	CTL	Control signal input terminal. This terminal is set to High-Level (+2.5V~VDD) or Low-Level (0~+0.8V).

NJG1602HE3

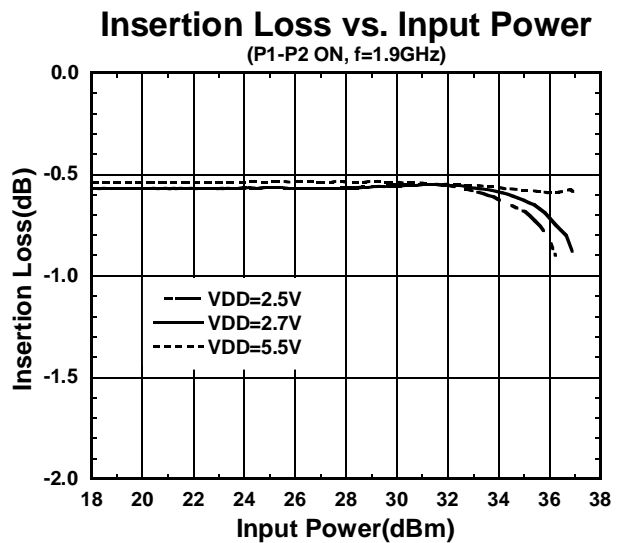
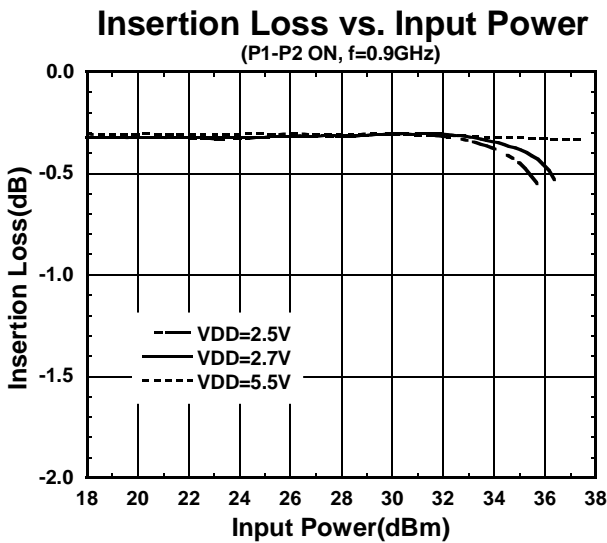
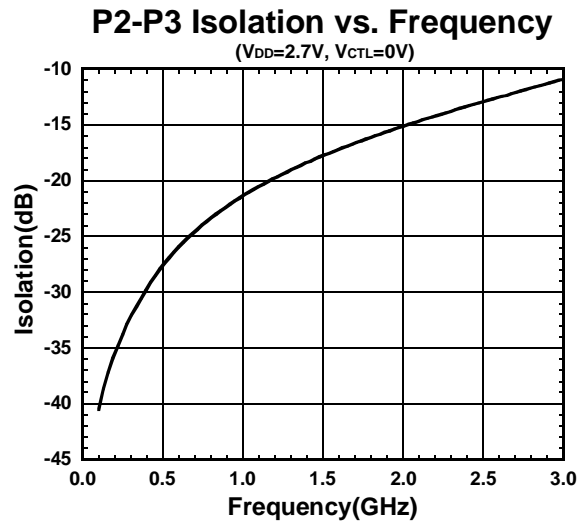
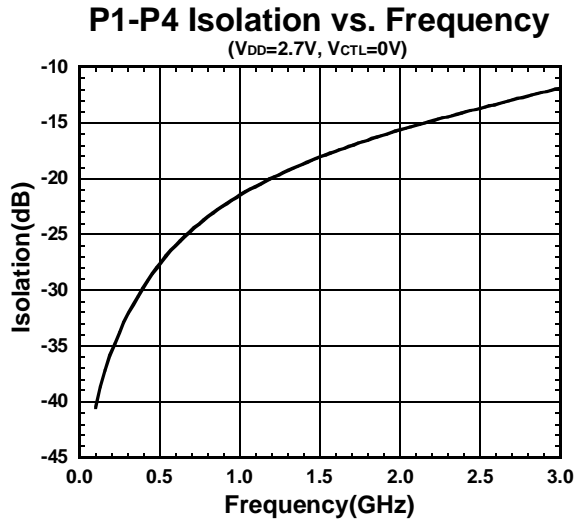
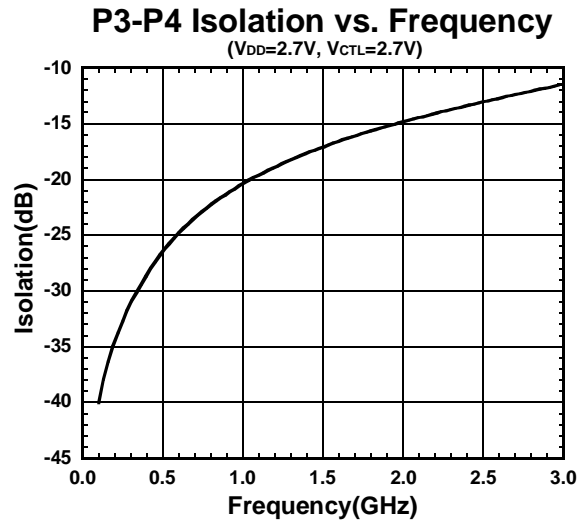
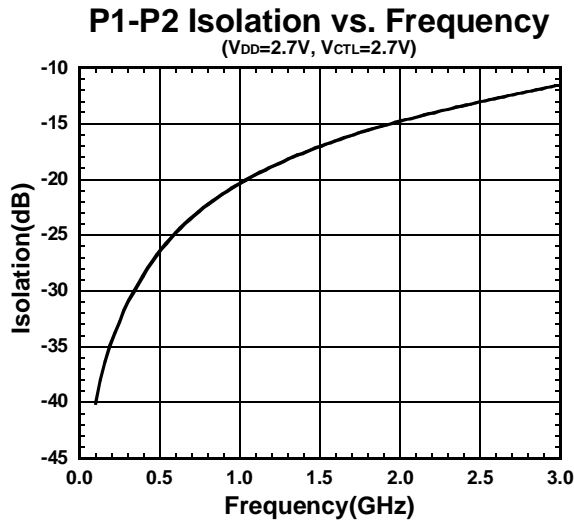
■ ELECTRICAL CHARACTERISTICS

(0.1~3.0GHz, with application circuit, Losses of external circuit are excluded)



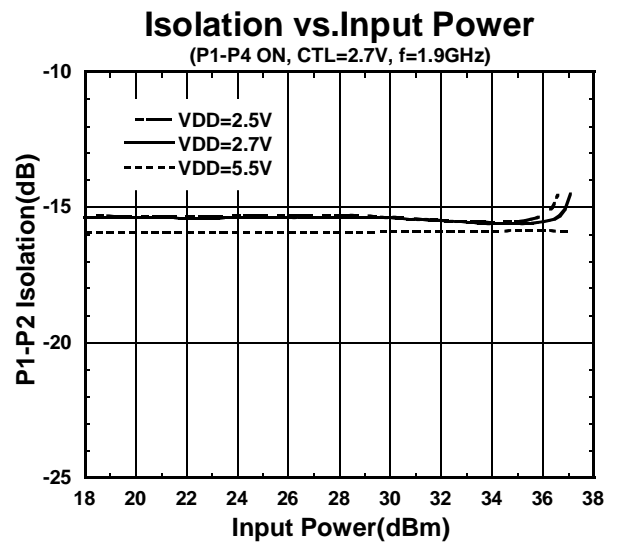
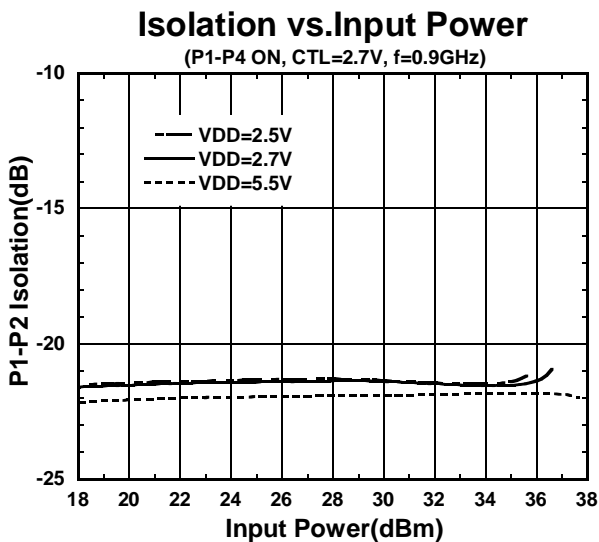
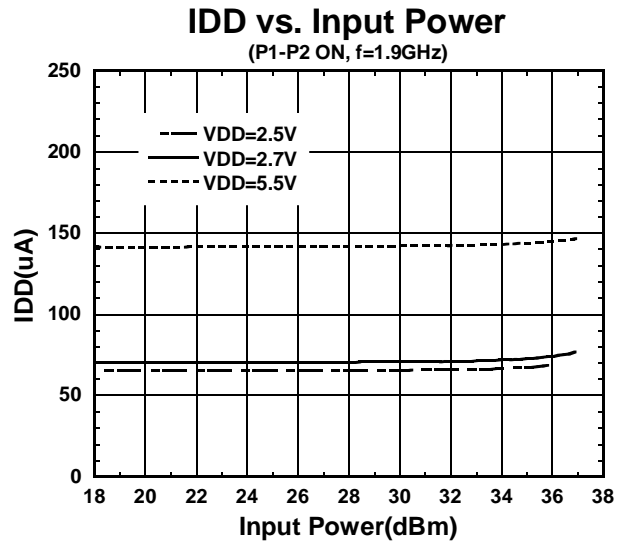
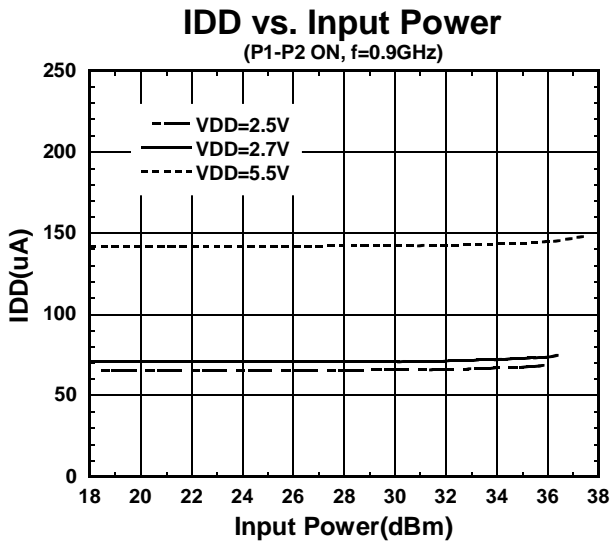
■ ELECTRICAL CHARACTERISTICS

(0.1~3.0GHz, with application circuit, Losses of external circuit are excluded)

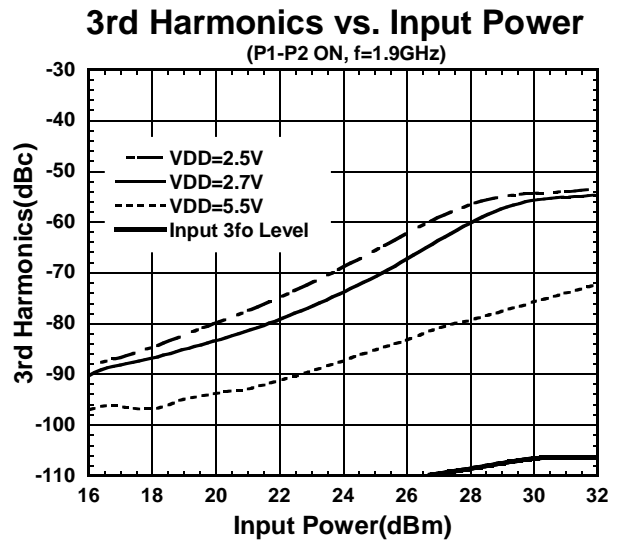
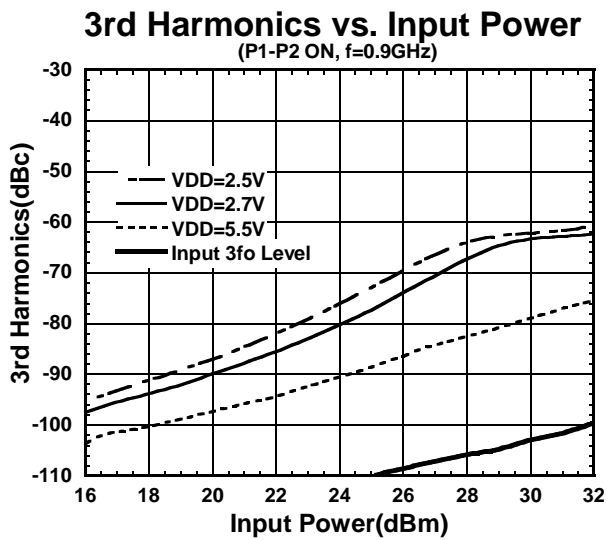
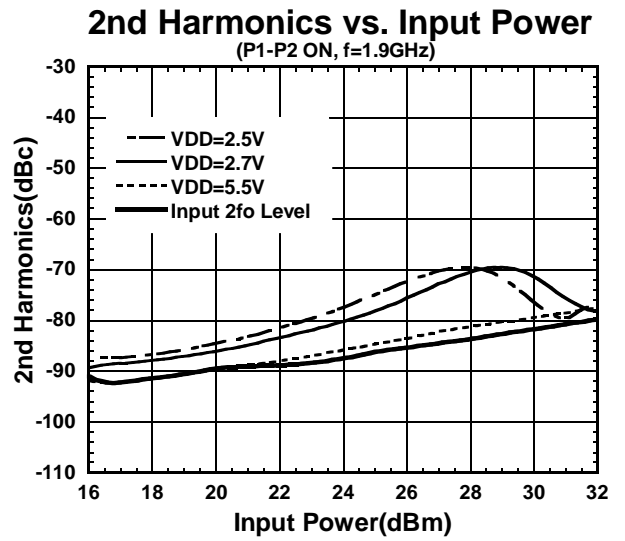
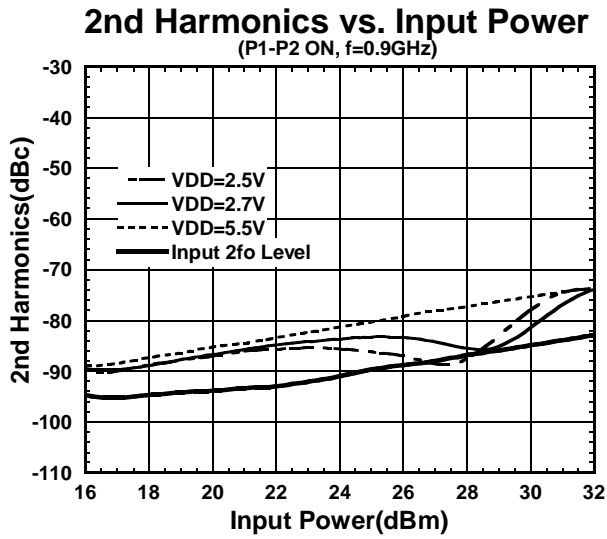


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■ ELECTRICAL CHARACTERISTICS (with application circuit)

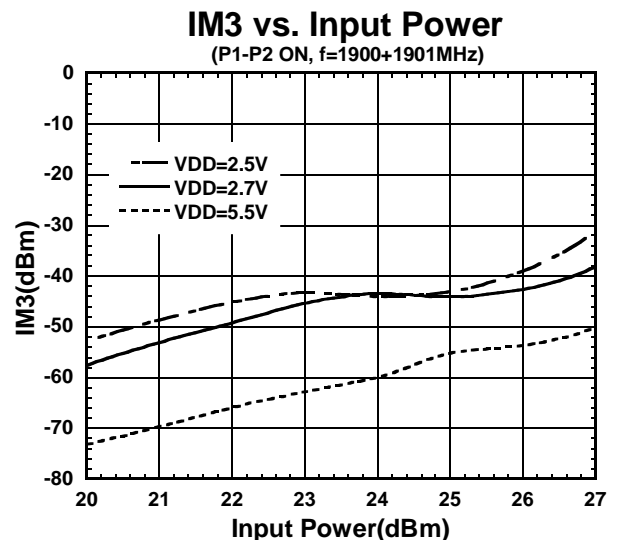
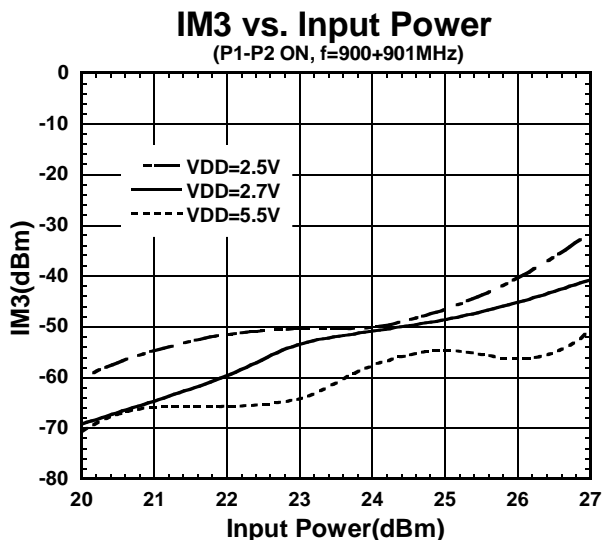
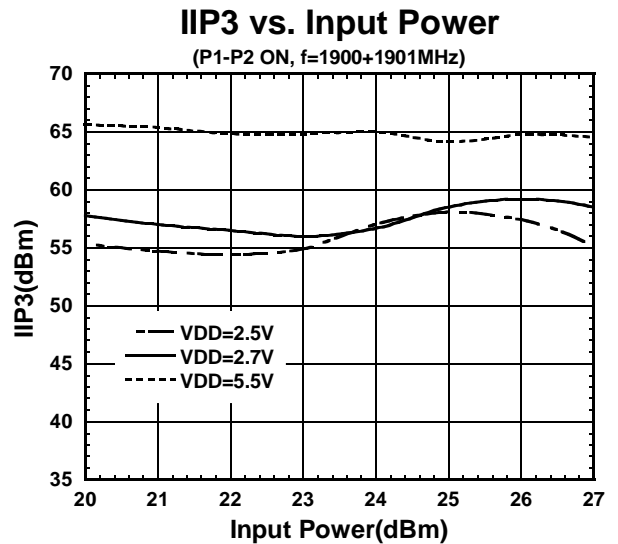
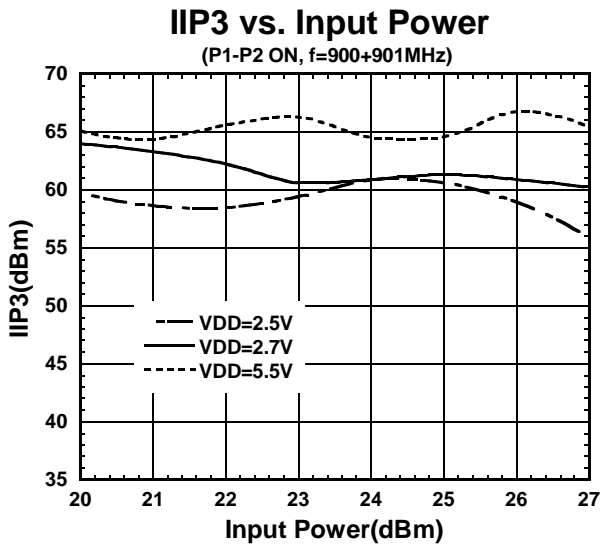
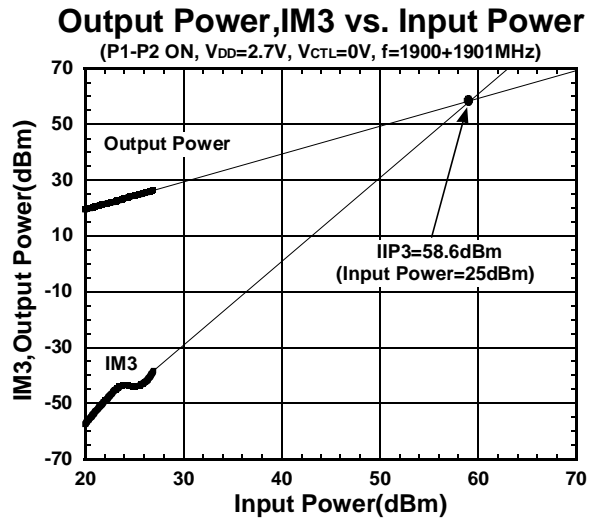
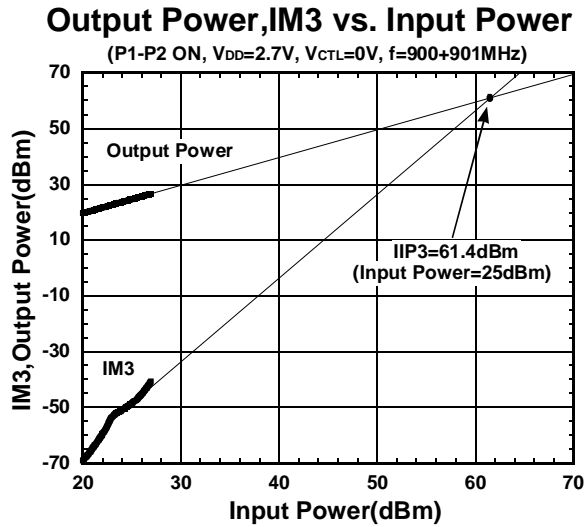


■ ELECTRICAL CHARACTERISTICS (with application circuit)



NJG1602HE3

■ ELECTRICAL CHARACTERISTICS (with application circuit)

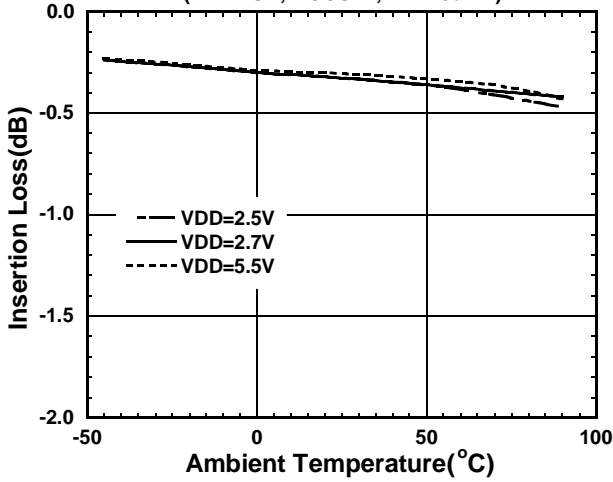


ELECTRICAL CHARACTERISTICS

(with application circuit, Losses of external circuit are excluded)

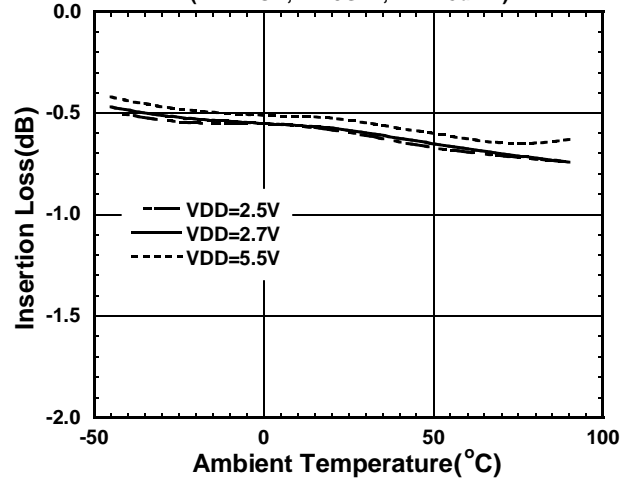
Insertion Loss vs. Ambient Temperature

(P1-P2 ON, f=0.9GHz, Pin=25dBm)



Insertion Loss vs. Ambient Temperature

(P1-P2 ON, f=1.9GHz, Pin=25dBm)

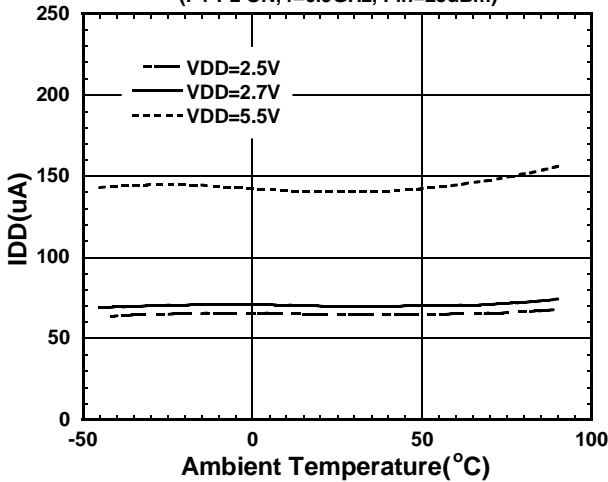


ELECTRICAL CHARACTERISTICS

(with application circuit)

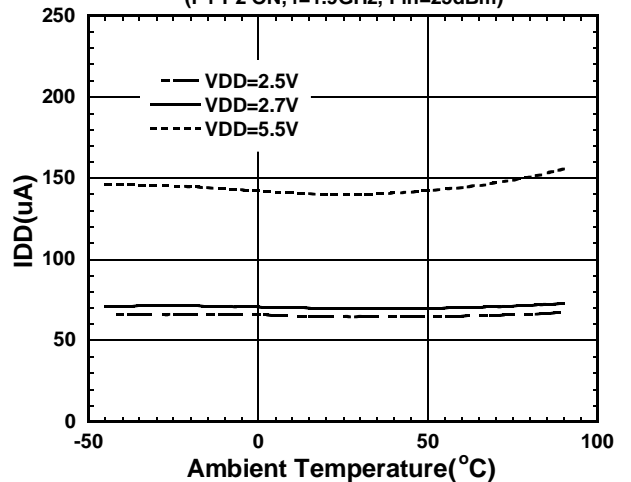
IDD vs. Ambient Temperature

(P1-P2 ON, f=0.9GHz, Pin=25dBm)



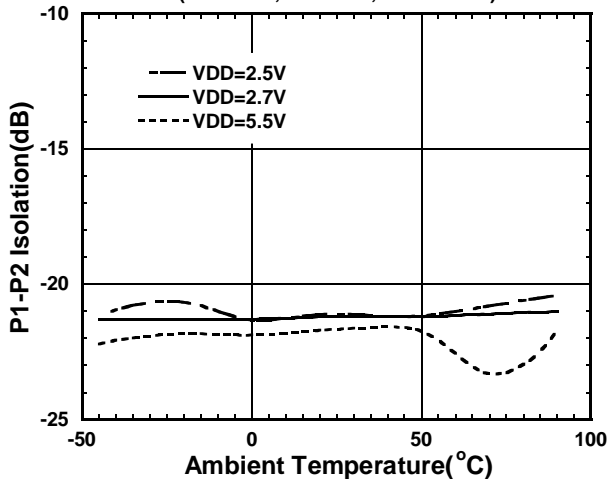
IDD vs. Ambient Temperature

(P1-P2 ON, f=1.9GHz, Pin=25dBm)



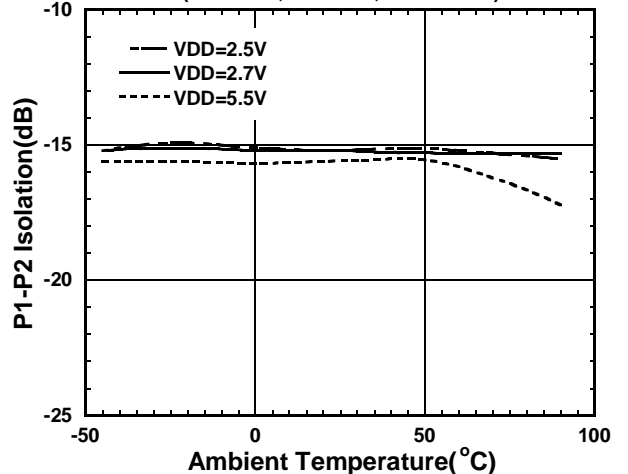
Isolation vs. Ambient Temperature

(P1-P4 ON, f=0.9GHz, Pin=25dBm)



Isolation vs. Ambient Temperature

(P1-P4 ON, f=1.9GHz, Pin=25dBm)



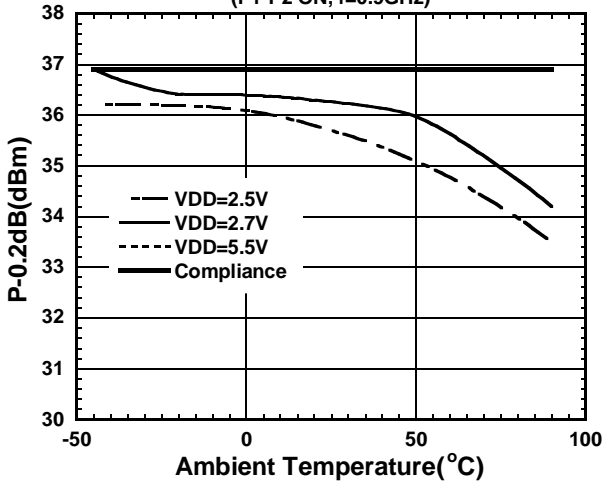
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ELECTRICAL CHARACTERISTICS

(with application circuit)

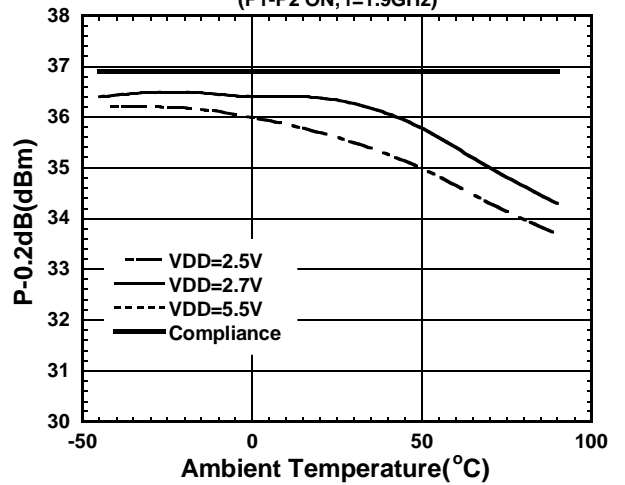
P-0.2dB vs. Ambient Temperature

(P1-P2 ON, f=0.9GHz)



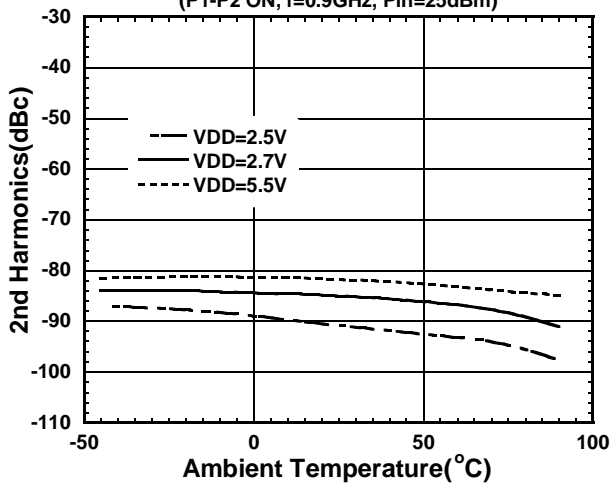
P-0.2dB vs. Ambient Temperature

(P1-P2 ON, f=1.9GHz)



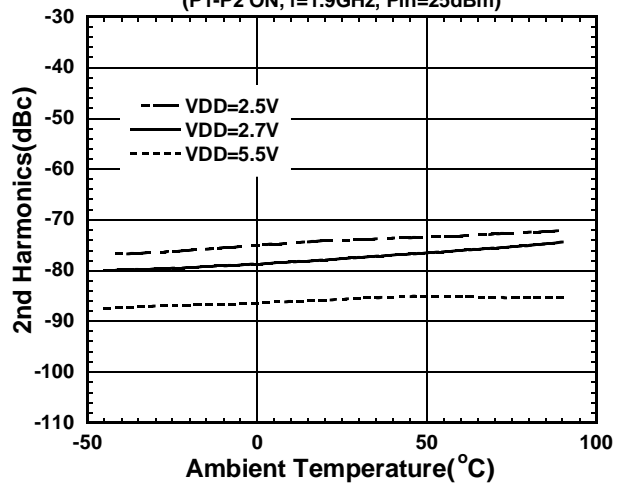
2nd Harmonics vs. Ambient Temperature

(P1-P2 ON, f=0.9GHz, Pin=25dBm)



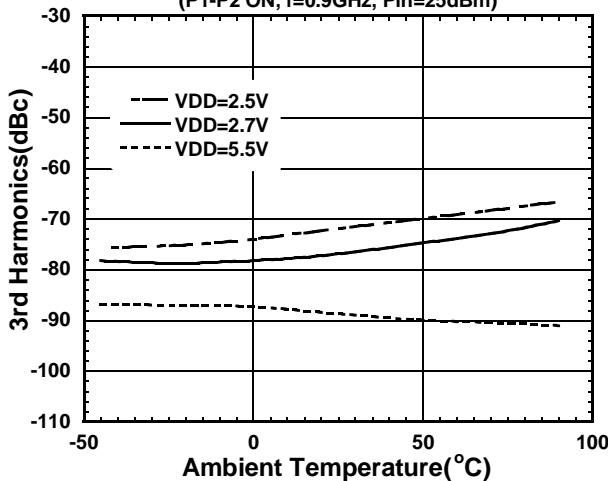
2nd Harmonics vs. Ambient Temperature

(P1-P2 ON, f=1.9GHz, Pin=25dBm)



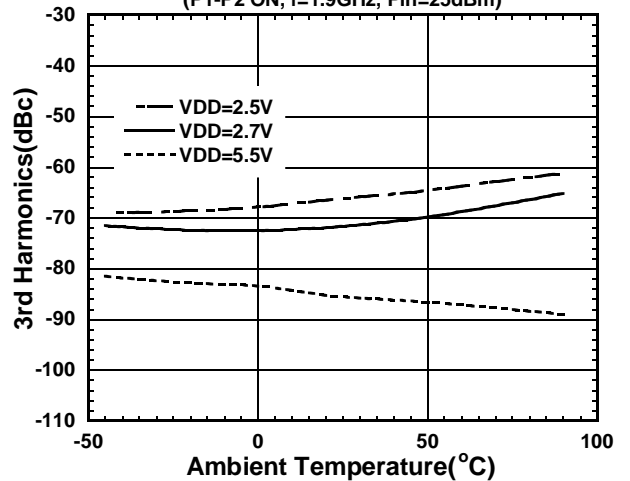
3rd Harmonics vs. Ambient Temperature

(P1-P2 ON, f=0.9GHz, Pin=25dBm)

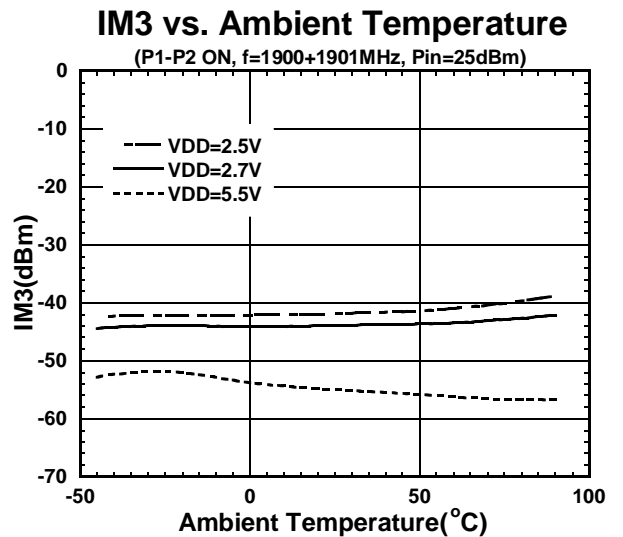
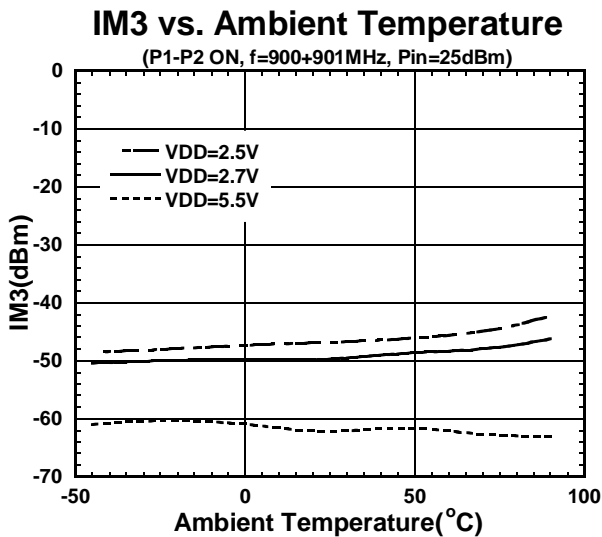
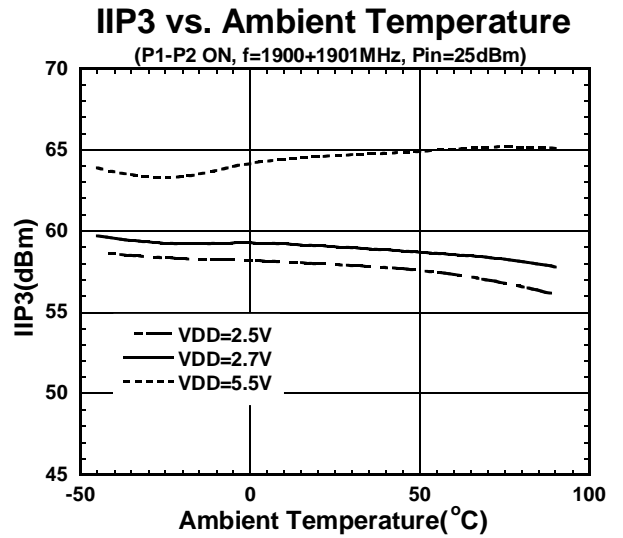
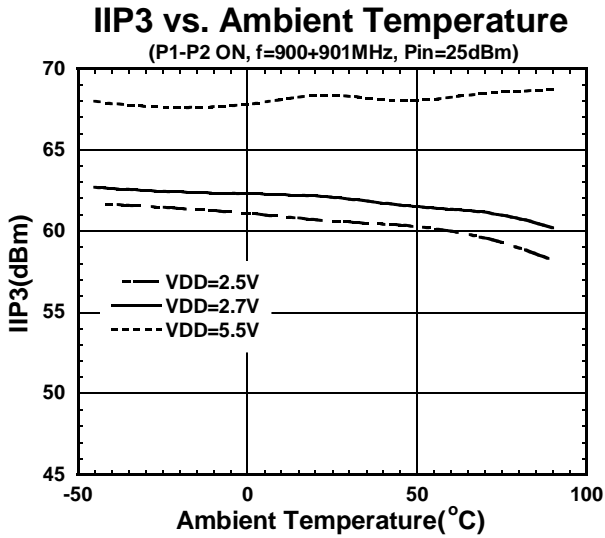


3rd Harmonics vs. Ambient Temperature

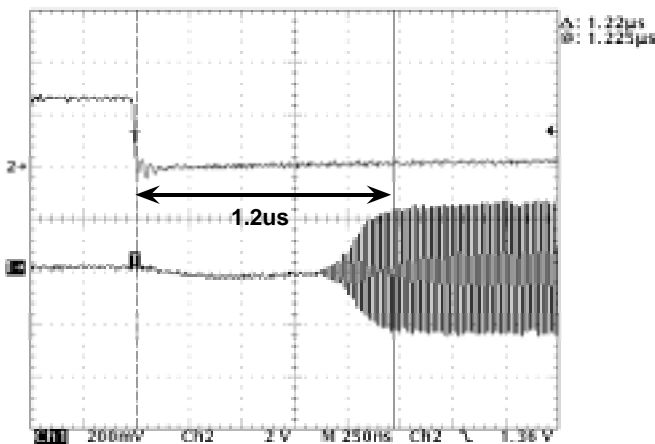
(P1-P2 ON, f=1.9GHz, Pin=25dBm)



■ ELECTRICAL CHARACTERISTICS (with application circuit)

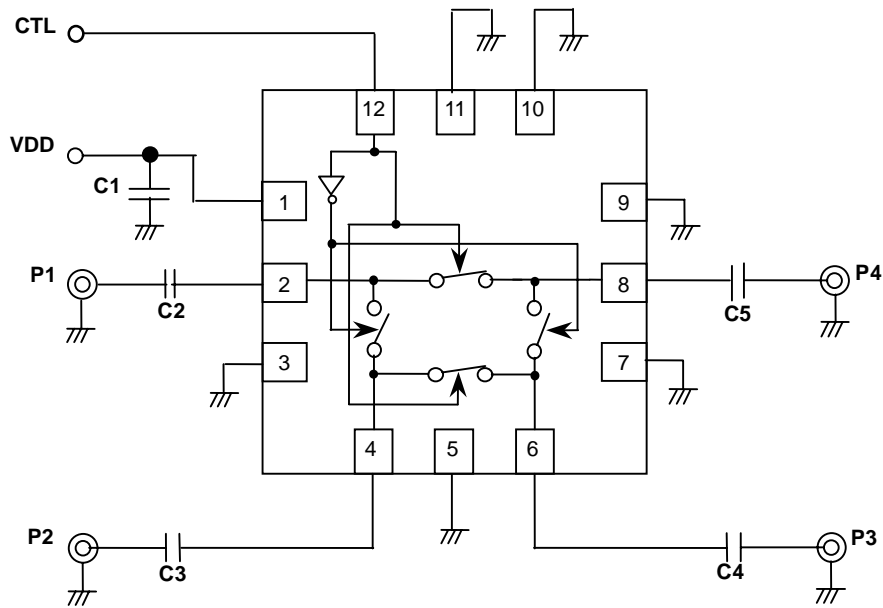


Switching Speed
(Vctl(L)=0V, Vctl(H)=2.7V)



NJG1602HE3

PACKAGE OUTLINE (USB12-E3)

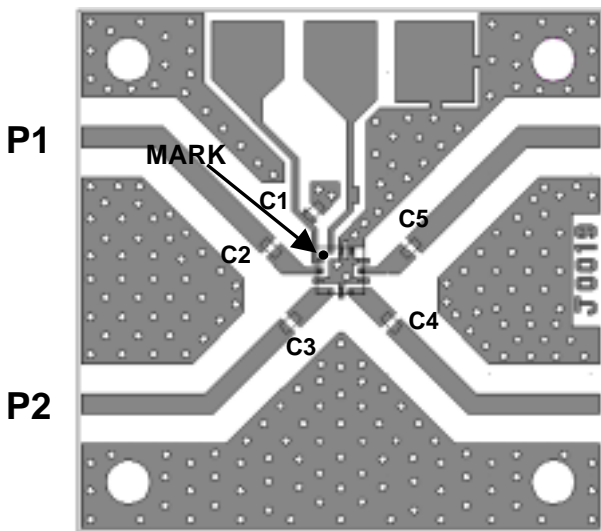


PARTS LIST

Parts		Notes
C1	1000pF	MURATA (GRP15)
C2-C5	56pF	MURATA (GRP15)

RECOMMENDED PCB DESIGN

VDD CTL GND

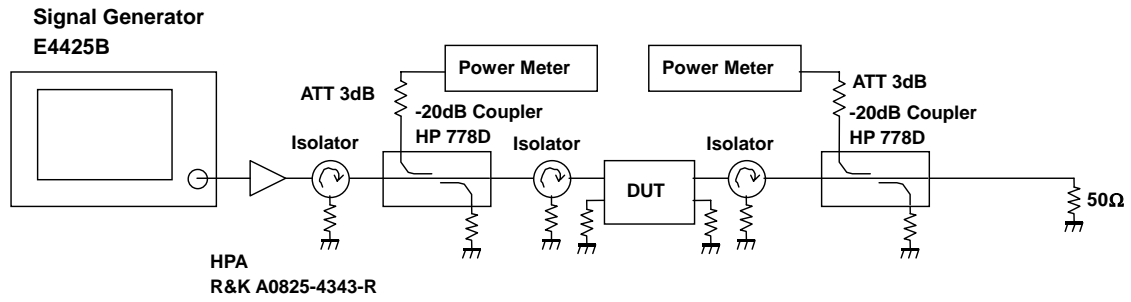


PCB SIZE=26mmX26mm
 PCB: FR-4, t=0.5mm
 Capacitor: size 1005
 Strip line Width=1.0mm ($Z_0=50\Omega$)

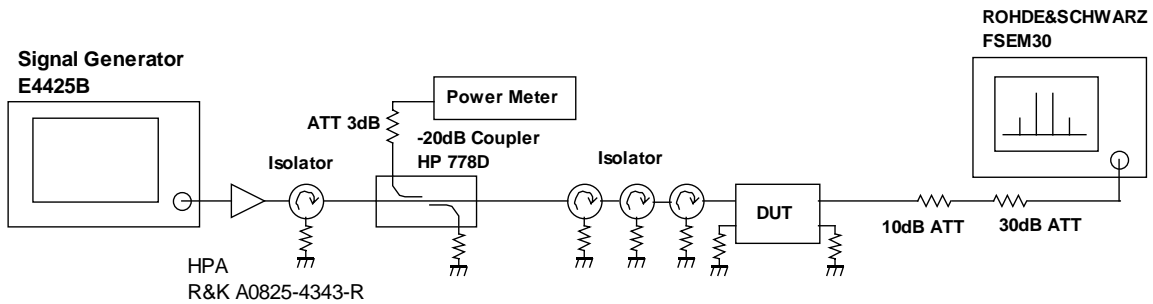
■Circuit losses including losses of capacitors and connectors

Frequency	900MHz	1.9GHz
Loss(dB)	0.20dB	0.32dB

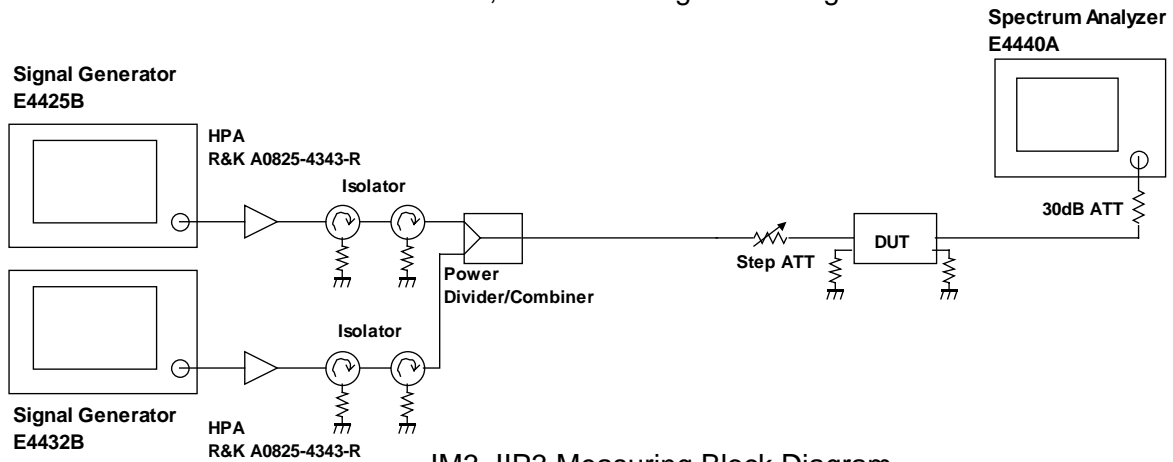
MEASURING BLOCK DIAGRAM



Pin-Pout Measuring Block Diagram



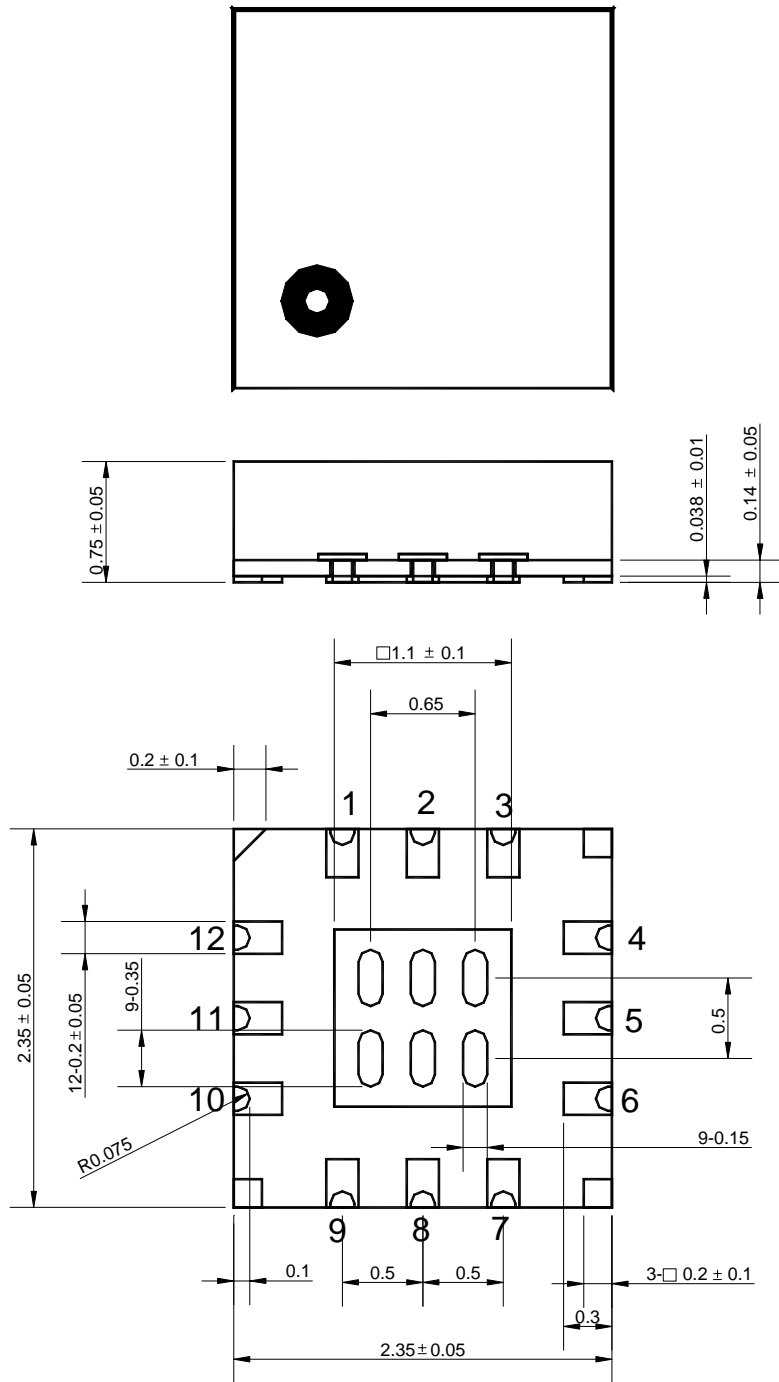
2fo, 3fo Measuring Block Diagram



IM3, IIP3 Measuring Block Diagram

NJG1602HE3

PACKAGE OUTLINE(USB12-E3)



NAL TREAT :Au
 :FR5
 Molding material : Epoxy resin
 UNIT :mm
 WEIGHT :17mg

Cautions on using this product

- This product contains Gallium-Arsenide (GaAs) which is a harmful material.
- Do NOT eat or put into mouth.
 - Do NOT dispose in fire or break up this product.
 - Do NOT chemically make gas or powder with this product.
 - To waste this product, please obey the relating law of your country.

[CAUTION]

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Мы предлагаем:

- Конкурентоспособные цены и скидки постоянным клиентам.
- Специальные условия для постоянных клиентов.
- Подбор аналогов.
- Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.
- Приемлемые сроки поставки, возможна ускоренная поставка.
- Доставку товара в любую точку России и стран СНГ.
- Комплексную поставку.
- Работу по проектам и поставку образцов.
- Формирование склада под заказчика.
- Сертификаты соответствия на поставляемую продукцию (по желанию клиента).
- Тестирование поставляемой продукции.
- Поставку компонентов, требующих военную и космическую приемку.
- Входной контроль качества.
- Наличие сертификата ISO.

В составе нашей компании организован Конструкторский отдел, призванный помогать разработчикам, и инженерам.

Конструкторский отдел помогает осуществить:

- Регистрацию проекта у производителя компонентов.
- Техническую поддержку проекта.
- Защиту от снятия компонента с производства.
- Оценку стоимости проекта по компонентам.
- Изготовление тестовой платы монтаж и пусконаладочные работы.

